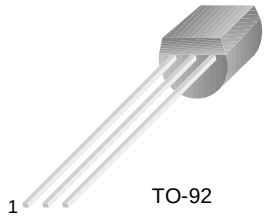
FAIRCHILD
SEMICONDUCTOR®

MPSA12

NPN Darlington Transistor

- This device is designed for applications requiring extremely high current gain at currents to 1.0A.
- Sourced from process 05.
- See MPSA14 for characteristics.



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1. Emitter 2. Base 3. Collector

Absolute Maximum Ratings * T_A=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	20	V
V_{CBO}	Collector-Base Voltage	20	V
V_{EBO}	Emitter-Base Voltage	10	V
I_C	Collector Current - Continuous	1.2	A
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:
1. These ratings are based on a maximum junction temperature of 150 degrees C.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristics						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	I_C = 100μA, I_E = 0	20			V
I_{CBO}	Collector Cutoff Current	V_{CB} = 15V, I_E = 0			100	nA
I_{CES}	Emitter Cutoff Current	V_{CB} = 15V, I_C = 0			100	nA
I_{EBO}	Emitter Cutoff Current	V_{EB} = 10V, I_C = 0			100	nA
On Characteristics *						
h_{FE}	DC Current Gain	V_{CE} = 5.0V, I_C = 10mA	20,000			
V_{CE}(sat)	Collector-Emitter Saturation Voltage	I_C = 10mA, I_B = 0.01mA			1.0	V
V_{BE}(on)	Base-Emitter On Voltage	I_C = 10mA, V_{CE} = 5.0V			1.4	V

* Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

Thermal Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
P_D	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

Package Demensions

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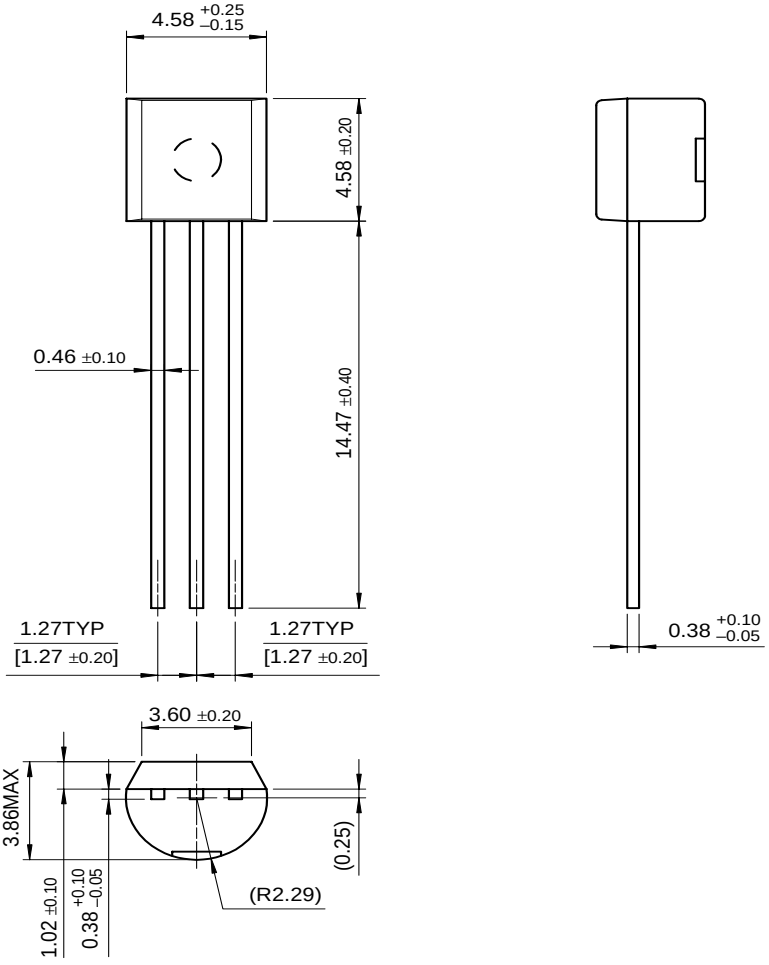

Dimensions in Millimeters

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